

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MASAHIRO EBISU	02/03/2016
HIROSHI HAMADA	02/04/2016
YASUSHI SAKUMA	02/04/2016
SHIGENORI HAYAKAWA	02/04/2016
RECEIVING PARTY DATA	
Name:	OCLARO JAPAN, INC.
Street Address:	4-1-55 OYAMA, CHUO-KU, SAGAMIHARA,
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	252-5250
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15042655
CORRESPONDENCE DATA	
Fax Number:	(703)684-1157
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-684-1120
Email:	svannarath@mmpiaw.com
Correspondent Name:	MATTINGLY & MALUR, PC
Address Line 1:	1800 DIAGONAL ROAD
Address Line 2:	SUITE 210
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	HPTA-10306
NAME OF SUBMITTER:	JOHN R. MATTINGLY
SIGNATURE:	/John R. Mattingly/
DATE SIGNED:	02/12/2016
Total Attachments: 1	
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ASSIGNMENT
(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Oclaro Japan, Inc.
a corporation organized under the laws of Japan,
located at 4-1-55 Oyama, Chuo-ku, Sagamihara, Kanagawa, 252-5250 Japan
receipt of which is hereby acknowledged I do hereby sell and assign to said Oclaro Japan, Inc.
its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR LIGHT RECEIVING DEVICE, OPTICAL RECEIVER MODULE AND
MANUFACTURING METHOD THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,
to be held and enjoyed by said Oclaro Japan, Inc.
its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Oclaro Japan, Inc.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>胡 匡洋</u> Masahiro EBISU	<u>3, Feb, 2016</u>
2) <u>濱田 博</u> Hiroshi HAMADA	<u>4, Feb, 2016</u>
3) <u>左久間 康</u> Yasushi SAKUMA	<u>4, Feb, 2016</u>
4) <u>早川 茂則</u> Shigenori HAYAKAWA	<u>4, Feb, 2016</u>
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____